

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L13	787	68/12.18,12.19,12.22.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 09:39
L14	5	13 and heat\$3 near3 mix\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 09:44
L15	1719	heat\$3 near3 (liquid or fluid or solvent) and heat\$3 near3 (additive or \$3solvent or surfactant or dissolvent) and pump and mix\$3 near3 heat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/14 09:48
L16	175	15 and supercritical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/14 10:08
L17	342	(wafer or semiconductor or substrate or workpiece) and pump and supercritical and mix\$3 near3 heat\$3 and heat\$3 near3 (liquid or fluid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/14 10:59
L18	114	(wafer or semiconductor or substrate or workpiece) and pump and supercritical and (mix\$3 or manifold) near3 heat\$3 not 17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/14 10:59
S1	13	US-5071485-\$.DID. OR US-5090221-\$.DID. OR US-5261965-\$.DID. OR US-5267455-\$.DID. OR US-5377705-\$.DID. OR US-5417768-\$.DID. OR US-5494526-\$.DID. OR US-5505219-\$.DID. OR US-5509431-\$.DID. OR US-5514220-\$.DID. OR US-5642743-\$.DID. OR US-5772787-\$.DID. OR US-5908510-\$.DID.	US-PGPUB; USPAT	OR	ON	2005/09/13 08:34

S2	13	US-5071485-\$.DID. OR US-5090221-\$.DID. OR US-5261965-\$.DID. OR US-5267455-\$.DID. OR US-5377705-\$.DID. OR US-5417768-\$.DID. OR US-5494526-\$.DID. OR US-5505219-\$.DID. OR US-5509431-\$.DID. OR US-5514220-\$.DID. OR US-5642743-\$.DID. OR US-5772783-\$.DID. OR US-5908510-\$.DID.	US-PGPUB; USPAT	OR	ON	2005/09/12 15:01
S3	1	"20020048731"	US-PGPUB; USPAT	OR	ON	2005/09/09 14:31
S4	4	(S2 or S3) and pump and valve and pressur\$4 and (additive or cosolvent) and mix\$3 and supercritical and liquid	US-PGPUB; USPAT	OR	ON	2005/09/09 14:37
S5	4	"634458".ap.	US-PGPUB; USPAT	OR	ON	2005/09/09 14:34
S6	4	(S2 or S3) and pump and valve and pressur\$4 and (additive or cosolvent) and mix\$3 and supercritical and liquid and heat\$3	US-PGPUB; USPAT	OR	ON	2005/09/09 14:54
S7	0	134/99.2,100.1,104.2,105,107	US-PGPUB; USPAT	OR	ON	2005/09/09 14:55
S8	1705	134/99.2,100.1,104.2,105,107. ccls.	US-PGPUB; USPAT	OR	ON	2005/09/09 14:55
S9	328	S8 and (wafer or substrate or semiconductor or workpiece)	US-PGPUB; USPAT	OR	ON	2005/09/09 14:55
S10	0	S9 and pump and heat\$3 near3 (additive or cosolvent or co?solvent) and heat\$3 near dioxide	US-PGPUB; USPAT	OR	ON	2005/09/09 14:56
S11	2	S9 and pump and heat\$3 near3 (additive or cosolvent or co?solvent) and heat\$3 near (liquid or fluid)	US-PGPUB; USPAT	OR	ON	2005/09/09 14:58
S12	2	S9 and pump and heat\$3 near3 (additive or cosolvent or co-solvent) and heat\$3 near (liquid or fluid)	US-PGPUB; USPAT	OR	ON	2005/09/09 15:10
S13	6	(wafer or semiconductor or substrate or workpiece) and pump and valve and heat\$3 near3 (additive and (fluid or liquid)) and supercritical and mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/09 15:12

S14	3724	(wafer or semiconductor or substrate or workpiece) and heat\$3 near3 (additive or cosolvent or surfactant)	US-PGPUB; USPAT	OR	ON	2005/09/12 14:53
S15	2719	(wafer or semiconductor or substrate or workpiece) and heat\$3 near3 (additive)	US-PGPUB; USPAT	OR	ON	2005/09/12 15:02
S16	13	US-5071485-\$.DID. OR US-5090221-\$.DID. OR US-5261965-\$.DID. OR US-5267455-\$.DID. OR US-5377705-\$.DID. OR US-5417768-\$.DID. OR US-5494526-\$.DID. OR US-5505219-\$.DID. OR US-5509431-\$.DID. OR US-5514220-\$.DID. OR US-5642743-\$.DID. OR US-5772783-\$.DID. OR US-5908510-\$.DID.	US-PGPUB; USPAT	OR	ON	2005/09/12 15:01
S17	0	S16 and heat\$3 near3 additive	US-PGPUB; USPAT	OR	ON	2005/09/12 15:01
S18	0	S16 and heat\$3 near3 (additive or cosolvent or surfactant)	US-PGPUB; USPAT	OR	ON	2005/09/12 15:02
S19	145	S15 and pump and valve and mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/12 15:07
S20	10	S19 and supercritical	US-PGPUB; USPAT	OR	ON	2005/09/12 15:13
S21	0	(wafer or semiconductor or substrate or workpiece) and pump and valve and mix\$3 and supercritical and heat\$3 near5 (additive or cosolvent or surfactant)	USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 15:14
S22	5	(wafer or semiconductor or substrate or workpiece) and pump and valve and mix\$3 and heat\$3 near5 (additive or cosolvent or surfactant)	USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 15:14
S23	26	(wafer or semiconductor or substrate or workpiece) and pump and mix\$3 and heat\$3 near5 (additive or cosolvent or surfactant)	USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 15:16
S24	268	pump and mix\$3 and heat\$3 near5 (additive or cosolvent or surfactant)	USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 16:18

S25	25062	(fluid or liquid or solvent or additive) near3 heat\$3 and mix\$3 near3 heat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 16:30
S26	720	S25 and supercritical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 17:09
S27	66	heat\$3 near3 stream\$3 near3 before near3 mix\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/09/12 17:09
S28	2117	134/100.1,102.1,102.2,107,105. ccls.	US-PGPUB; USPAT	OR	ON	2005/09/13 08:41
S29	42	S28 and heat\$3 near3 mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/13 08:41
S30	420	S28 and heat\$3 and mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/13 08:42
S31	2	S30 and heat\$3 near3 (fluid or liquid or solvent) and heat\$3 near3 (additive or cosolvent or surfactant)	US-PGPUB; USPAT	OR	ON	2005/09/13 08:43
S32	60	S30 and heat\$3 near3 (fluid or liquid or solvent) and heat\$3 near3 (additive or \$solvent or surfactant)	US-PGPUB; USPAT	OR	ON	2005/09/13 08:46
S33	60	S30 and heat\$3 near3 (fluid or liquid or solvent) and heat\$3 near3 (additive or \$3solvent or surfactant)	US-PGPUB; USPAT	OR	ON	2005/09/13 08:46
S34	2053	(supply or feed) near3 stream near3 mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/13 11:26
S35	95	S34 and supercritical	US-PGPUB; USPAT	OR	ON	2005/09/13 10:38
S36	421	(supply or feed) near3 stream near3 heat\$3 same mix\$3	US-PGPUB; USPAT	OR	ON	2005/09/13 11:27
S37	17	S36 and supercritical	US-PGPUB; USPAT	OR	ON	2005/09/13 11:27

S38	24	("20020112740" "5013366" "5482564" "5494526" "5514220" "5522938" "5700379" "5783082" "5866005" "5868856" "5868862" "5908510" "5922833" "5944996" "5976264" "6001418" "6024801" "6030663" "6067728" "6092538" "6149828" "6240936" "6242165" "6277753").PN. OR ("6782900").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 09:37
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